Bell Labs Innovations

# L7597 Resistive Subscriber Line Interface Circuit (SLIC), Ring Relay, and Protector (SRP) for Short Loop and TA-909 Applications 

## Features

- Low-power scan mode for low on-hook power dissipation ( 40 mW )
- Low active power dissipation ( 125 mW max)
- Distortion-free, on-hook transmission
- Eight operating states via latched parallel data inputs with channel select feature
- Battery switch for dual power supply operation
- Precision fixed 25 mA current limiter
- Integrated protection
- No external protection device required
- Integrated ringing access relay
- Ring trip detector
- Loop closure detector with hysteresis
- Relay driver
- Battery noise cancellation
- Thermal protection
- 32-pin, surface-mount, plastic package (PLCC)


## Description

The L7597 is a resistive subscriber line interface circuit (SLIC) that is optimized for short loop applications, such as Bellcore TA-NWT-000909 requirements for the fiber-in-the-loop (FITL) applications. It interfaces with the low-voltage circuits on an analog line card to the Tip/Ring subscriber loop. The L7597 does not supply dc current to the subscriber loop; external resistors are used for this purpose.
Included in the L7597 are a solid-state ringing access switch and a line break switch. Also included is a relay driver for an external (test) access mechanical relay.

State control is via four latched parallel data inputs. A chip select feature allows the user to enable, disable, or rest the data latches to a known logic state.

The L7597 offers a low-power scan state to minimize power to less than 40 mW in the on-hook state. The active power is also very low ( $<125 \mathrm{~mW}$ ). The L7597 also supports on-hook transmission; however, power dissipation will be higher ( $<700 \mathrm{~mW}$ ) in the on-hook transmission state.
To minimize the off-hook power that is dissipated in the subscriber loop, the L7597 also offers a battery switch feature. The high-voltage battery is applied during an on-hook condition, to maintain compatibility with any preexisting standards. In an off-hook condition, the battery is switched via a logic input to a lower-voltage auxiliary battery, thus minimizing offhook power dissipation. Because the battery is switched via an external logic control, the battery switch is only suited for applications where the lowervoltage battery is sufficient to drive the loop; i.e., short loop applications. Current is limited to a fixed value of 25 mA by an internal precision current-limit circuit.

Because of the internal architecture of the L7597 SLIC and because of the power rating of the associated external feed resistors, the L7597 will meet most surge requirements without use of an external secondary protection device. Internal circuitry steers both positive and negative faults to fault ground. Negative faults are not dumped into the battery.
The L7597 is a chip line interface solution package in a single 32 -pin PLCC package. The Tip and Ring drive amplifiers, the XMT amplifier, the receive interface, and battery noise cancellation circuits are fabricated in a 90 V complementary bipolar (CBIC) process. The ring access switch, line break switch, battery switch, current limit, protection functions, supervision, and control functions are fabricated in a 320 V dielectrically isolated bipolar-CMOS-DMOS (BCDMOS) process. The device is available in a 32-pin PLCC package.

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## Architectural Diagram



Figure 1. Architectural Diagram

## Pin Information



12-3331.a (C)
Figure 2. Pin Layout

Table 1. Pin Descriptions

| Pin | Symbol | Type | Name/Function |
| :---: | :---: | :---: | :--- |
| 1 | IRCV | I | Receive Signal Input (+). The differential current flowing from PT to PR is 200 times <br> the current flowing into IRCV. |
| 2 | VccA | - | +5 Volt Analog dc Supply. +5 V supply for analog circuitry. |
| 3 | CBN | I | Battery Noise Capacitor. The current flowing out of PR is -100 times the voltage <br> applied to CBN divided by the impedance connected between RGBN and AGND. <br> Connect a capacitor from CBN to VBF to eliminate battery noise from the Tip/Ring. |
| 4 | RGBN | I | Battery Noise Gain Resistor. The current flowing out of PR is 100 times the current <br> flowing into RGBN. Connect a resistor from RGBN to AGND to set the gain of the <br> battery noise cancellation circuit. |
| 5 | AGND | - | Analog Ground. Ground return for analog circuitry. |
| 6 | NSTAT | O | Not Loop Status. When low, this logic output indicates either a ring trip or an off- <br> hook condition, depending on the input state of the SLIC. |
| 7 | CS | I | Channel Select. A low-to-high transition on this logic input stores the data on pins <br> B0-B3 into the input latches on the SLIC. |
| 8 | B3 | I | Bit 3. B0-B3 determine the state of the SLIC. See Operating States. <br> 9 |
| 10 | B2 | I | I |
| 11 | Bit 2. B0-B3 determine the state of the SLIC. See Operating States. |  |  |
| Bit 1. B0-B3 determine the state of the SLIC. See Operating States. |  |  |  |

## Pin Information (continued)

Table 1. Pin Descriptions (continued)

| Pin | Symbol | Type | Name/Function |
| :---: | :---: | :---: | :---: |
| 12 | CE | I | Channel Enable. A low on this logic input resets latches B0-B3 to the 1111 state and disables the channel select input CS. A high on this logic input enables the channel select input CS. |
| 13 | VDD | - | +5Volt Digital dc Supply. +5 V supply for logic and switch circuitry. |
| 14 | DGND | - | Digital Ground. Ground return for VDD and the relay driver. |
| 15 | RDO | 0 | Relay Driver. This output drives an external relay. |
| 16 | RTS | 1 | Ring Trip Sense. Sense input for the ring trip detector. |
| 17 | RSW | 0 | Ringing Access Switch. Ringing relay connects this pin to pin VRNG (ringing supply). Connect this pin to pin VBF through a $600 \Omega$ current-limiting resistor. |
| 18 | VRNG | - | Ringing Supply Voltage. Connect this pin to the ringing supply. |
| 19 | Vвath | - | High Office Battery Supply. Most negative high-voltage power supply. |
| 20 | VBF* | - | Feed Resistor Battery Supply. Negative battery and ringing supply for the loop. Connect this pin to the Ring of the loop through a $200 \Omega$ battery feed resistor. |
| 21 | FGND* | - | Fault Ground. Ground return which carries the fault current when the fault protection is operated. |
| 22 | PR | I/O | Protected Ring. The input to the Ring fault protection and output of Ring current drive amplifier (via the Ring access switch). Connect this pin to the Ring of the loop through a $1 \mathrm{k} \Omega$ overvoltage protection resistor. |
| 23 | PT | 1/0 | Protected Tip. The input to the Tip fault protection and output of Tip current drive amplifier. Connect this pin to the Tip of the loop through a $1 \mathrm{k} \Omega$ overvoltage protection resistor. |
| 24 | CLIM | 1 | Current-Limiter Capacitor. Connect a $0.1 \mu \mathrm{~F}$ capacitor from this pin to pin $\mathrm{V}_{\text {BF }}$ |
| 25 | Vbatl | - | Low Office Battery Supply. Least negative high-voltage power supply. |
| 26 | AGND | - | Analog Ground. Ground return for analog circuitry. |
| 27 | Vcca | - | +5 Volt Analog dc Supply. +5 V supply for analog circuitry. |
| 28 | Vвath | - | High Office Battery Supply. Most negative high-voltage power supply. |
| 29 | XMT | 0 | Transmit Signal Output. Transmit amplifier output to codec. |
| 30 | TS | I | Tip Sense. Negative (-) input of transmit op amp. Connect one high-value resistor between TS and the Tip of the loop and another high-value resistor between TS and XMT. |
| 31 | RS | I | Ring Sense. Positive (+) input of the transmit op amp. Connect one high-value resistor between RS and the Ring of the loop and another high value resistor between RS and AGND. |
| 32 | RCVN | 1 | Receive Signal Input ( - ). The differential current flowing from PT to PR is -200 times the voltage applied to RCVN divided by the impedance connected between IRCV and AGND. |

[^1]
## Absolute Maximum Ratings ( $@ T_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the data sheet. Exposure to absolute maximum ratings for extended periods of time can adversely affect device reliability.

| Parameter | Symbol | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: |
| +5 V dc Supplies | VCCA \& VDD | -0.5 | - | 7.0 | V |
| High Office Battery Supply | VBATH | -63 | - | +0.5 | V |
| Low Office Battery Supply | VBATL | VBATH | - | +0.5 | V |
| Logic Input Voltage | - | -0.5 | - | VDD +0.5 | V |
| Logic Input Clamp Diode Current, per Pin | - | - | $\pm 20$ | - | mA |
| Logic Output Voltage | - | -0.5 | - | VDD $+0.5^{\mathrm{V}}$ | V |
| Logic Output Current, per Pin <br> (excluding relay driver) | - | - | $\pm 35$ | - | mA |
| Operating Temperature Range | - | -40 | - | 125 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | Tsta | -40 | - | 125 | ${ }^{\circ} \mathrm{C}$ |
| Relative Humidity Range | - | 5 | - | 95 | $\%$ |
| Ground Potential Difference (DGND to AGND) | - | - | $\pm 3$ | - | V |

Notes:
Analog voltages (VCcA, VBATH, and VBATL) are referenced to AGND and digital (logic) voltages (VdD) are referenced to DGND.
The IC can be damaged unless all ground connections are applied before, and removed after, all other connections. Furthermore, when powering the device, the user must guarantee that no external potential creates a voltage on any pin of the device that exceeds the device ratings. For example, inductance in a supply lead could resonate with the supply filter capacitor to cause a destructive overvoltage.

## Electrical Characteristics

In general, minimum and maximum values are testing requirements. However, some parameters may not be tested in production because they are guaranteed by design and device characterization. Typical values reflect the design center or nominal value of the parameter; they are for information only and are not a requirement. Minimum and maximum values apply across the entire temperature range ( $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ) and entire battery range ( -35 V to -60 V ). Unless otherwise specified, typical is defined as $25^{\circ} \mathrm{C}, \mathrm{VccA}=+5.0 \mathrm{~V}, \mathrm{VDD}=+5.0 \mathrm{~V}$, $\mathrm{V}_{\text {BATH }}=-48 \mathrm{~V}$, $\mathrm{V}_{\text {batl }}=-25.5 \mathrm{~V}$. Positive currents flow into the device.

Table 2. Operating Conditions and Powering

| Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Temperature Range | -40 | - | 85 | ${ }^{\circ} \mathrm{C}$ |
| Humidity Range | 5 | - | $95^{1}$ | \%RH |
| Supply Voltages: <br> Vcca <br> Vdd <br> Vbath <br> Vbatl <br> Vcca - Vdd | $\begin{aligned} & 4.6 \\ & 4.6 \\ & -35 \\ & -20 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 5.0 \\ & -48 \\ & -25 \end{aligned}$ | $\begin{gathered} 5.5 \\ 5.5 \\ -60 \\ \text { V Bath }^{2} \\ \pm 0.5 \end{gathered}$ | $\begin{aligned} & V \\ & V \\ & V \\ & V \\ & V \end{aligned}$ |
| ```Supply Currents (scan state; no loop current): IVcca + IVdd (+5 V) IVватн ( -48 V ) IVbatl (-25.5 V)``` | - | - | $\begin{gathered} 3.0 \\ -500 \\ -100 \end{gathered}$ | $\begin{aligned} & \mathrm{mA} \\ & \mu \mathrm{~A} \\ & \mu \mathrm{~A} \end{aligned}$ |
| ```Supply Currents (talk state; no loop current): IVcca + IVdd (+5 V) IV Ватн (-48 V) IVbatl (-25.5 V)``` | - | - | $\begin{gathered} 4.5 \\ -1.6 \\ -500 \end{gathered}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \\ & \mu \mathrm{~A} \end{aligned}$ |
| ```Supply Currents (on-hook transmission; no loop current): IVcca + IVdd (+5 V) IVbath (-48 V) IVbatl (-25.5 V)``` | - | - | $\begin{array}{r} 15.0 \\ -18.0 \\ -100 \\ \hline \end{array}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \\ & \mu \mathrm{~A} \end{aligned}$ |
| Total Power Dissipation (no loop current): <br> $($ Vcca \& Vdd $=+5 \mathrm{~V}$; Vbath $=-48 \mathrm{~V}$; Vbatl $=-25.5 \mathrm{~V})$ <br> Talk State <br> Scan State <br> On-hook Transmission State | - | - | $\begin{gathered} 125 \\ 40 \\ 700 \end{gathered}$ | $\begin{aligned} & \mathrm{mW} \\ & \mathrm{~mW} \\ & \mathrm{~mW} \end{aligned}$ |
| Power Supply Rejection (Tip/Ring) ${ }^{2}$ : <br> Vcca ( $500 \mathrm{~Hz}-3 \mathrm{kHz} ; 50 \mathrm{mV}$ rms ripple) <br> Vdd ( $500 \mathrm{~Hz}-3 \mathrm{kHz} ; 50 \mathrm{mVrms}$ ripple) <br> $V_{\text {batl }}$ and Vbath ( $500 \mathrm{~Hz}-1 \mathrm{kHz} ; 50 \mathrm{mVrms}$ ripple) $)^{3}$ <br> Vbatl and Vbath ( $1 \mathrm{kHz}-3 \mathrm{kHz} ; 50 \mathrm{mVrms}$ ripple) ${ }^{3}$ | $\begin{aligned} & 40 \\ & 50 \\ & 40 \\ & 35 \end{aligned}$ | 50 <br> - <br> 40 | - | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| Thermal ${ }^{2}$ : <br> Thermal Resistance (still air) Operating Tjc Thermal Shutdown Temperature | - | $\overline{145}$ | $\begin{gathered} 60 \\ 135 \end{gathered}$ | $\begin{aligned} & { }^{\circ} \mathrm{C} / \mathrm{W} \\ & { }^{\circ} \mathrm{C} \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |

1. Not to exceed 26 grams of water per kilogram of dry air.
2. This parameter is not tested in production. It is guaranteed by design and device characterization.
3. Vbath and Vbatl power supply rejection depends on the battery noise cancellation circuit. The performance stated here applies to Vbatl only during the talk state and VBATH only during the on-hook transmission state and assumes proper battery noise cancellation; i.e., a $0.1 \mu \mathrm{~F}$ capacitor from VBF to CBN (see Figure 14). The $1 \mathrm{kHz}-3 \mathrm{kHz}$ power supply rejection can be improved by at least 6 dB with an additional series RC ( $50 \mathrm{k} \Omega+47 \mathrm{pF}$ ) network connected from RGBN to AGND (see Figure 14).

## Electrical Characteristics (continued)

## Ring Trip Detector

## Table 3. Ring Trip Detector

| Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Ringing Source ${ }^{1}$ : Frequency (f) dc Voltage ac Voltage | $\begin{gathered} 17 \\ -36 \\ 60 \end{gathered}$ | 20 | $\begin{array}{r} 28 \\ -57 \\ 105 \\ \hline \end{array}$ | $\begin{gathered} \mathrm{Hz} \\ \mathrm{~V} \\ \mathrm{~V} \mathrm{rms} \end{gathered}$ |
| Ring Trip ${ }^{2}$ (NSTAT $=0$ ): <br> Loop Resistance Trip Time ( $\mathrm{f}=20 \mathrm{~Hz}$ ) NSTAT Valid | $1330$ | - | $\begin{gathered} \overline{200} \\ 80 \end{gathered}$ | $\begin{gathered} \Omega \\ \mathrm{ms} \\ \mathrm{~ms} \end{gathered}$ |

1. The ringing source consists of the ac and dc voltages added together (battery backed ringing); the ringing return is battery ground.
2. Pretrip: Ringing must not be tripped by a $10 \mathrm{k} \Omega$ resistor in parallel with a $6 \mu \mathrm{~F}$ capacitor applied across Tip and Ring.

## Battery Feed

Table 4. Battery Feed

| Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Loop Resistance Range ${ }^{1}$ ( 3.17 dBm overload into 600 W ): ILOop $=20 \mathrm{~mA}$ at $\mathrm{V}_{\text {batL }}=-24.2 \mathrm{~V}$ ILOop $=25 \mathrm{~mA}$ at VBatL $=-25.5 \mathrm{~V}$ | $\begin{aligned} & 700 \\ & 525 \end{aligned}$ | - | - | $\begin{aligned} & \Omega \\ & \Omega \end{aligned}$ |
| Longitudinal Current Capability per Wire ${ }^{2}$ | 8.5 | - | - | mArms |
| dc Loop Current Limit (RLoop = 200 W ) | 23.75 | 25 | 26.25 | mA |
| Current-limiter ac Output Impedance ${ }^{3}$ : 200 Hz to 4 kHz | - | - | 50 | $\Omega$ |
| Current-limiter Transient Current (In response to a step voltage change on $\mathrm{V}_{\mathrm{BF}}$ ) | 8 | - | 150 | mA |
| ```Switchhook Detector Loop Resistance4: Off Hook (NSTAT = 0) On Hook (NSTAT = 1)``` | $5000$ | $4000$ | $3 \overline{-}$ | $\begin{aligned} & \Omega \\ & \Omega \\ & \Omega \end{aligned}$ |
| ```Longitudinal to Metallic Balance-IEEE \({ }^{5}\) Std. 4556: 200 Hz to 1 kHz 1 kHz to 3 kHz``` | $\begin{aligned} & 50 \\ & 45 \end{aligned}$ | - | - | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| Metallic to Longitudinal (Harm) Balance ${ }^{7}$ : 200 Hz to 4 kHz | 30 | - | - | dB |

1. Assumes $2 \times 200 \Omega$ external dc feed resistors.
2. When the current-limit circuit is active and the battery switch is off, the longitudinal current must be less than the dc loop current to ensure proper ac transmission.
3. Assumes CLIM $=0.1 \mu \mathrm{~F}$; CLIM determines the ac output impedance of the current-limit circuit when it is active.
4. Detector values are independent of office battery and are valid over the entire range of VBATH and VBatL. However, NSTAT must indicate an on hook (NSTAT = 1) if either VBATH or VBatL is disconnected (open circuit) from its dc source and an off hook at the power supply pins as follows (the pins of supplies that have more than one pin are shorted together): when CS is high (thermal shutdown $=0 \mathrm{~V}$ ). Vbath and $\mathrm{V}_{\text {batL }}$ are defined as disconnected depending on the voltage at the power supply pins as follows (the pins of supplies that have more than one pin are shorted together):

- If $\mathrm{V}_{\text {bath }} \leq-20 \mathrm{~V}$ (i.e., more negative than -20 V ) and V batl $\leq-20 \mathrm{~V}$, then NSTAT must operate normally.
- If Vbath $\geq-10 \mathrm{~V}$ (i.e., more positive than -10 V ) or VbatL $\geq-10 \mathrm{~V}$, then NSTAT must be on hook (NSTAT $=1$ ).

5. IEEE is a registered trademark of The Institute of Electrical and Electronics Engineers, Inc.
6. Assumes the external dc feed resistors are matched to $0.4 \%$ and proper battery noise cancellation; i.e., a $0.1 \mu \mathrm{~F}$ capacitor from VBF to CBN.
7. Assumes proper battery noise cancellation; i.e., a $0.1 \mu \mathrm{~F}$ capacitor from VBF to CBN.

## Electrical Characteristics (continued)

## Fault Protection

## Pins PT, PR, and VbF

Pins PT, PR, and VbF are protected by SCRs which clamp surge currents (both positive and negative) to FGND. If the SCR on PR or VbF triggers due to a negative surge, the L7597 automatically switches to the disconnect state while the SCR is conducting current above its hold current. After the SCR releases, the L7597 automatically switches back to the operating state prior to the SCR trigger.

Table 5. Electrical Characteristics of Pins PT, PR, and VbF

| Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| PT and PR: |  |  |  |  |
| Surge Current ${ }^{1}$ : |  |  |  |  |
| Lightning-10 $\mu \mathrm{s} \times 1000 \mu \mathrm{~s}$ | - | - | $\pm 1$ | A |
| Lightning-2 $\mu \mathrm{s} \times 10 \mu \mathrm{~s}$ | - | - | $\pm 2.5$ | A |
| Power Cross-60 Hz, 1 s | - | - | 200 | mArms |
| Power Cross-60 Hz, 15 min . | - | - | 50 | mArms |
| SCR Trigger Voltage Pin PT: |  |  |  |  |
| Positive | Vcca-2 | - | Vcca +4 | V |
| Negative | -25 | - | -35 | V |
| dc Transient Response | -25 | - | -55 | V |
| SCR Trigger Voltage Pin PR: |  |  |  |  |
| Positive | 150 | - | 280 | V |
| Negative | -220 | - | -320 | V |
| SCR Hold Current (positive and negative) | 10 | - | - | mA |
| VBF: |  |  |  |  |
| Surge Current ${ }^{1}$ : |  |  |  |  |
| Lightning-10 $\mu \mathrm{s} \times 1000 \mu \mathrm{~s}$ | - | - | $\pm 5.5$ | A |
| Lightning-2 $\mu \mathrm{s} \times 10 \mu \mathrm{~s}$ | - | - | $\pm 13$ | A |
| Power Cross-60 Hz, 1 s | - | - | 800 | mArms |
| Power Cross-60 Hz, 15 min . | - | - | 150 | mArms |
| SCR Trigger Voltage: |  |  |  |  |
| Positive | 150 | - | 280 | V |
| Negative | -220 | - | -320 | V |
| SCR Hold Current (positive and negative) | 10 | - | - | mA |
| Trigger Current (if from a power supply-PT, PR, and VBF) | - | - | $\pm 250$ | $\mu \mathrm{A}$ |
| dV/dt Sensitivity ${ }^{1,2}$ (PT, PR, and VBF) | - | 500 | - | $\mathrm{V} / \mu \mathrm{s}$ |

1. This parameter is not tested in production. It is guaranteed by design and device characterization.
2. Applied voltage is 50 Vpp square wave at 100 Hz to measure $\mathrm{dV} / \mathrm{dt}$ sensitivity.

## Electrical Characteristics (continued)

## Fault Protection (continued)

## Loss of Power Supplies

The L7597 must protect itself from lightning and power cross voltages on Tip and Ring if any (or any combination) of the power supplies (Vcca, Vdd, Vbath, and $\mathrm{V}_{\text {batl }}$ ) are disconnected (open circuit) from their dc source. Additionally, if any power supply is disconnected, no overvoltage on Tip or Ring can cause a supply voltage to exceed its maximum rating. Under these conditions, Vcca and Vdd are considered as one supply (Vcca shorted to Vdd), the pins of supplies which have more than one pin are shorted together, and bypass capacitors are connected. To satisfy these requirements (and also to disconnect ringing from the loop when ring trip cannot be detected), the L7597 is placed into the disconnect state depending on the voltage at the power supply pins as shown below.

Table 6. Loss of Power Supplies

| Parameter | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: |
| Vcca \& VdD: |  |  |  |  |
| Normal Operating State (as defined by control logic) | 1 | - | - | V |
| Disconnect State | - | - | 4.5 | V |
| VBAtH: |  |  |  |  |
| Normal Operating State (as defined by control logic) | -10 | - | -75 | V |
| Disconnect State | - | - | -20 | V |
| Disconnect State | -65 | - | - | V |

## Analog Signal Pins

Table 7. Analog Signal Pins

| Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| PT and PR: |  |  |  |  |
| Surge Current (See the Protection section.) |  |  |  |  |
| Output Drive (PT): |  |  |  |  |
| Positive (sink) Drive Current | +15 | - | - | mA |
| Negative Voltage Swing (lout $=+15 \mathrm{~mA}$ ) | -25 | - | Vвath | V |
| Negative (source) Drive Current | -10 | - | - | mA |
| Positive Voltage Swing (lout $=-0.1 \mathrm{~mA}$ ) | Vcca-2 | - | Vcca | V |
| Positive Voltage Swing (lout $=-10 \mathrm{~mA}$ ) | Vcca- 3.5 | - | Vcca | V |
| Output Drive (PR): |  |  |  |  |
| Positive (sink) Drive Current | +10 | - | - | mA |
| Negative Voltage Swing (lout $=+0.1 \mathrm{~mA}$ ) | Vbath +2 | - | Vbath | V |
| Negative Voltage Swing (lout $=+10 \mathrm{~mA}$ ) | Vbath +4.5 | - | Vbath | V |
| Negative (source) Drive Current | -20 | - | - | mA |
| Positive Voltage Swing (lout $=-20 \mathrm{~mA}$ ) | -5 | - | Vcca | V |
| Output Short-circuit Transient Current ${ }^{1}$ | - | - | $\pm 125$ | mA |
| Output Impedance ( $60 \mathrm{~Hz}-3.4 \mathrm{kHz})^{2}$ | 250 | - | - | $\mathrm{k} \Omega$ |
| Output Load Resistance (dc or ac) | 100 | - | - | $\Omega$ |
| Output Load Capacitance ${ }^{2}$ | - | - | 1 | nF |

[^2]Electrical Characteristics (continued)

## Analog Signal Pins (continued)

Table 7. Analog Signal Pins (continued)

| Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| XMT: |  |  |  |  |
| Output Drive Current | $\pm 1$ | - | - | mA |
| Output Voltage Swing (1 mA load): |  |  |  |  |
| Maximum | Vbath | - | Vcca | V |
| Minimum | Vbath +5 | - | +2.5 | V |
| Output Short-circuit dc Current ${ }^{1}$ | - | - | $\pm 20$ | mA |
| Output Impedance ( $60 \mathrm{~Hz}-3.4 \mathrm{kHz})^{2}$ | - | - | 10 | $\Omega$ |
| Output Load dc Resistance ${ }^{2}$ | 50 | - | - | $\mathrm{k} \Omega$ |
| Output Load ac Impedance ${ }^{2}$ | 2 | - | - | $\mathrm{k} \Omega$ |
| Output Load Capacitance ${ }^{2}$ | - | - | 50 | pF |
| RCVN: |  |  |  |  |
| Input Voltage Range ${ }^{2}$ | -1.75 | - | 3.5 | V |
| Input Bias Current | - | - | $\pm 1$ | $\mu \mathrm{A}$ |
| Input Impedance ${ }^{2}$ | 20 | - | - | $\mathrm{M} \Omega$ |
| IRCV: |  |  |  |  |
| Input Offset Voltage (to RCVN) | - | - | $\pm 50$ | mV |
| Input Impedance | - | - | 5 | $\Omega$ |
| CBN: |  |  |  |  |
| Surge Current (lightning-10 $\mathrm{s} \times 1000 \mu \mathrm{~s}$ ) | - | - | $\pm 100$ | mA |
| Input Voltage Range ${ }^{2}$ | -1.75 | - | 3.5 | V |
| Input Bias Current | - | - | $\pm 250$ | nA |
| Input Impedance ${ }^{2}$ | 50 | - | - | $\mathrm{M} \Omega$ |
| RGBN: |  |  |  |  |
| Input Offset Voltage (to CBN) | - | - | $\pm 10$ | mV |
| Input Impedance ${ }^{2}$ | - | - | 5 | $\Omega$ |
| TS and RS: |  |  |  |  |
| Surge Current (from external source) | - | - | $\pm 25$ | mAdc |
| Input Voltage Range | Vbath +3 | - | AGND | V |
| Input Bias Current | - | - | $\pm 1$ | $\mu \mathrm{A}$ |
| Differential Input Impedance ${ }^{2}$ | 50 | - | - | k $\Omega$ |
| Common-mode Input Impedance ${ }^{2}$ | 50 | - | - | $\mathrm{M} \Omega$ |
| External Capacitance ( 67 kW source impedance) ${ }^{2}$ | - | - | 10 | pF |

1. A battery or ground short on PT, PR, or XMT will not cause a device failure.
2. This parameter is not tested in production. It is guaranteed by design and device characterization.

## Electrical Characteristics (continued)

## Transmission Characteristics

Transmit direction is Tip/Ring to XMT. Receive direction is IRCV/RCVN to Tip/Ring.
Table 8. ac Transmission Characteristics

| Parameter ${ }^{1}$ | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| ac Termination Impedance | - | 600 | - | $\Omega$ |
| $\begin{aligned} & \text { Return Loss²: } \\ & 200 \mathrm{~Hz}-500 \mathrm{~Hz} \\ & 500 \mathrm{~Hz}-2500 \mathrm{~Hz} \\ & 2500 \mathrm{~Hz}-3400 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 21 \\ & 26 \\ & 21 \end{aligned}$ | - | - | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| Tip/Ring Signal Level ( $600 \Omega$ reference) | - | - | 3.14 | dBm |
| Total Harmonic Distortion (200 Hz-4 kHz) ${ }^{2}$ | - | - | 0.3 | \% |
| Transmit Gain ( $\mathrm{f}=1 \mathrm{kHz}$ ): (Tip/Ring) to XMT | -0.486 | -0.500 | -0.514 | - |
| Receive Gain ( $\mathrm{f}=1 \mathrm{kHz}$ ): <br> IRCV to Differential Current Flowing from IPT to IPR RCVN to IRCV | $\begin{gathered} 195 \\ 0.995 \end{gathered}$ | $\begin{gathered} 200 \\ 1 \end{gathered}$ | $\begin{gathered} 205 \\ 1.005 \end{gathered}$ | - |
| $\begin{aligned} & \text { Gain vs. Frequency (transmit and receive; } 1 \mathrm{kHz} \text { reference) }{ }^{2} \text { : } \\ & 200 \mathrm{~Hz}-300 \mathrm{~Hz} \\ & 300 \mathrm{~Hz}-3.4 \mathrm{kHz} \\ & 3.4 \mathrm{kHz}-20 \mathrm{kHz} \\ & 20 \mathrm{kHz}-266 \mathrm{kHz} \end{aligned}$ | $\begin{gathered} -1.00 \\ -0.30 \\ -3.0 \end{gathered}$ | $\begin{aligned} & 0 \\ & 0 \\ & 0 \end{aligned}$ | $\begin{aligned} & 0.05 \\ & 0.05 \\ & 2.0 \\ & 2.0 \end{aligned}$ | dB |
| Gain vs. Level (transmit and receive; 0 dBV reference) ${ }^{2}$ : -50 dB to +3 dB | -0.05 | 0 | 0.05 | dB |
| $\begin{aligned} & \text { Transhybrid Loss²: } \\ & 200 \mathrm{~Hz}-500 \mathrm{~Hz} \\ & 500 \mathrm{~Hz}-2500 \mathrm{~Hz} \\ & 2500 \mathrm{~Hz}-3400 \mathrm{~Hz} \end{aligned}$ | $\begin{aligned} & 21 \\ & 26 \\ & 21 \\ & \hline \end{aligned}$ | - | - | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \\ & \hline \end{aligned}$ |
| Idle-channel Noise (Tip/Ring): Psophometric ${ }^{2}$ C-message 3 kHz Flat ${ }^{2}$ | - | - | $\begin{gathered} -77 \\ 12 \\ 20 \end{gathered}$ | dBmp dBrnC dBrn |
| Idle-channel Noise (XMT): Psophometric ${ }^{2}$ C-message 3 kHz Flat $^{2}$ |  | - | $\begin{gathered} -77 \\ 12 \\ 20 \end{gathered}$ | dBmp0 dBrnC0 dBrn0 |

1. Requires external components connected as shown in Figure 5. Transmission characteristics are specified assuming a $600 \Omega$ resistive termination and $\pm 1 \%$ external resistors.
2. This parameter is not tested in production. It is guaranteed by design and device characterization.

## Electrical Characteristics (continued)

## Data Interface and Logic

Table 9. Logic Inputs (CE, CS, and BO—B3) and Output NSTAT

| Parameter ${ }^{1}$ | Symbol | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| High-level Input Voltage | VIH | 2 | Vdd | V |
| Low-level Input Voltage | VIL | 0 | 0.8 | V |
| Input Bias Current (high and low) | IIN | - | $\pm 10$ | $\mu \mathrm{A}$ |
| High-level Output Voltage ( ${ }^{\text {lout }=-100 ~} \mu \mathrm{~A}$ ) | Voh | VDD-1.5 | VDD | V |
| Low-level Output Voltage (lout = $180 \mu \mathrm{~A}$ ) | VoL | 0 | 0.4 | V |
| Output Short-circuit Current (Vout = VDD) | Ioss | 1 | 35 | mA |
| Output Load Capacitance ${ }^{2}$ | Col | 0 | 50 | pF |

1. Unless otherwise specified, all logic voltages are referenced to DGND.
2. This parameter is not tested in production. It is guaranteed by design and device characterization.

## Timing Requirements (BO—B3 and CS)

A low-to-high transition on pin CS latches the data on pins B0-B3 into the device. When CS is either high or low, the device is unaffected by data on pins B0-B3. The status of the thermal shutdown circuit is output on B3 when CS is high (thermal shutdown $=0 \mathrm{~V}$ ). A low on channel enable lead CE asynchronously resets the data latch to 1111 (scan state with the relay driver off) and disables CS so that CS cannot latch any data into the device. A high on CE enables CS.

Table 10. Timing Requirements (B0—B3 and CS)

| Parameter ${ }^{1,2}$ | Symbol | Min | Max | Unit |
| :--- | :---: | :---: | :---: | :---: |
| CS Rise and Fall Time (10\% to 90\%) | tR, tF | 0 | 50 | ns |
| Maximum Input Capacitance | CIN | - | 5 | pF |
| Minimum Setup Time from B0-B3 Valid to CS | tSDS | 150 | - | ns |
| Minimum Hold Time from CS to B0-B3 Not Valid | tHDS | 50 | - | ns |
| Minimum Pulse Width of CS | tWCS | 225 | - | ns |

1. Unless otherwise specified, all times are measured from the $50 \%$ point of logic transitions.
2. These parameters are not tested in production. They are guaranteed by design and device characterization.

## Relay Driver (RDO)

The relay driver output RDO is low (relay operated) when a low input on B3 is latched into the device.
Table 11. Relay Driver (RDO)

| Parameter ${ }^{1}$ | Symbol | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Off-state Output Current (VRDO = VDD) | loff | - | $\pm 10$ | $\mu \mathrm{A}$ |
| On-state Output Voltage ( $\mathrm{IRDO}=70 \mathrm{~mA}$ ) | Von | 0 | 1.0 | V |
| On-state Output Voltage (IRDO $=20 \mathrm{~mA}$ ) | Von | 0 | 0.40 | V |
| Clamp Diode Reverse Current (VRDO = 0) | IR | - | $\pm 10$ | $\mu \mathrm{A}$ |
| Clamp Diode On Voltage (IRDO = 150 mA ) | Voc | VDD | VDD +2.0 | V |
| Turn-on Time ${ }^{2}$ | ton | - | 10 | $\mu \mathrm{s}$ |
| Turn-off Time ${ }^{2}$ | toff | - | 10 | $\mu \mathrm{s}$ |

1. Unless otherwise specified, all logic voltages are referenced to DGND.
2. This parameter is not tested in production. It is guaranteed by design and device characterization.

## Electrical Characteristics (continued)

## Switch Characteristics

Table 12. Battery Switch (SW1) and Ring Break Switch (SW2)

| Parameter | Min | Typ | Max | Unit |
| :--- | :---: | :---: | :---: | :---: |
| Off-state $^{1}:$ |  |  |  |  |
| Maximum Differential Voltage |  |  |  |  |
| dc Leakage Current (Vsw $= \pm 320 \mathrm{~V}$ ) | - | - | $\pm 320^{2}$ | V |
| Feedthrough Capacitance $^{3}$ | - | - | $\pm 50$ | $\mu \mathrm{~A}$ |
| On-state (See Figures 3 and 4.): | - | - | 50 | pF |
| Resistance (RoN) <br> Maximum Differential Voltage (Vmax) <br> Current Limit (LlımाT) | - | 50 | 100 | $\Omega$ |
| dV/dt Sensitivity ${ }^{3,4}$ | - | - | $320^{2}$ | V |

1. SW2 must be off if the voltage on pin PR is more positive than Vcca.
2. At $25^{\circ} \mathrm{C}$. Maximum voltage rating has a temperature coefficient of $+0.167 \mathrm{~V} /{ }^{\circ} \mathrm{C}$.
3. This parameter is not tested in production. It is guaranteed by design and device characterization.
4. Applied voltage is 100 Vpp square wave at 100 Hz to measure $\mathrm{dV} / \mathrm{dt}$ sensitivity.

Table 13. Ringing Access Switch (SW3)

| Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Off-state: |  |  |  |  |
| Maximum Differential Voltage | - | - | $\pm 500^{2}$ | V |
| dc Leakage Current (Vsw $= \pm 500 \mathrm{~V}$ ) | - | - | $\pm 20$ | $\mu \mathrm{A}$ |
| dc Leakage Current (Vsw $= \pm 250 \mathrm{~V}$ ) | - | - | $\pm 1$ | $\mu \mathrm{A}$ |
| Feedthrough Capacitance ${ }^{1}$ | - | - | 10 | pF |
| On-state (See Figures 3 and 4.): |  |  |  |  |
| Crossover Offset Voltage (Vos; Isw = $\pm 1 \mathrm{~mA}$ ) | - | - | 3 | V |
| Resistance (Ron) | - | - | 10 | $\Omega$ |
| Surge Current ( $10 \mu \mathrm{~s} \times 1000 \mu \mathrm{~s}$ pulse) ${ }^{3}$ | - | - | 2.0 | A |
| Release Current ${ }^{1}$ | 0.1 | - | 3 | mA |
| dV/dt Sensitivity ${ }^{3,4}$ | - | 500 | - | V/ $\mu \mathrm{s}$ |

1. SW2 must be off if the voltage on pin PR is more positive than VccA.
2. At $25^{\circ} \mathrm{C}$. Maximum voltage rating has a temperature coefficient of $+0.167 \mathrm{~V} /{ }^{\circ} \mathrm{C}$.
3. This parameter is not tested in production. It is guaranteed by design and device characterization.
4. Applied voltage is 100 Vpp square wave at 100 Hz to measure $\mathrm{dV} / \mathrm{dt}$ sensitivity.

## Electrical Characteristics (continued)

Switch Characteristics (continued)
Switch On-State V-I Characteristics


12-3332 (C)
Figure 3. Switch On-State V-I Characteristics SW1 and SW2


Figure 4. Switch On-State V-I Characteristics SW3

## Operating States

The L7597 has eight operating states. These states are selected using three logic input bits, B0-B2, according to the truth table shown in Table 14. Logic input B3 operates a relay driver independent of the state of bits $\mathrm{B} 0-\mathrm{B} 2$. Data on the parallel data bus, $\mathrm{B} 0-\mathrm{B} 3$, is loaded into a 4-bit latch on the L7597 on the low-tohigh transition of the channel select lead CS. Changes in the data at inputs B0-B3 do not affect the L7597 while CS is either low or high. A low on channel enable lead CE asynchronously resets the 4-bit latch to 1111 (scan state with the relay driver off) and disables the channel select lead CS (i.e., CS is prevented from loading any data into the 4 -bit latch). A high on CE enables CS. State transitions and delays between transitions are left to the discretion of the user since, except for fault conditions described later, the state of the L7597 depends only on the external control provided through the logic interface.

Table 14. Input State Coding

| CE | B3 | B2 | B1 | B0 | State |
| :---: | :---: | :---: | :---: | :---: | :--- |
| 0 | X | X | X | X | Scan state with relay driver off |
| 1 | X | 1 | 1 | 1 | Scan |
| 1 | X | 1 | 1 | 0 | Disconnect |
| 1 | X | 1 | 0 | 1 | Talk/high battery |
| 1 | X | 1 | 0 | 0 | Talk |
| 1 | X | 0 | 1 | 1 | Scan current limit |
| 1 | X | 0 | 1 | 0 | Ringing |
| 1 | X | 0 | 0 | 1 | On-hook transmission |
| 1 | X | 0 | 0 | 0 | Intermediate talk state |
| 1 | 0 | X | X | X | Relay driver output (RDO) is <br> low (relay active) |
| 1 | 1 | X | X | X | Relay driver output (RDO) is <br> high (relay not active) |

## Scan State

- Normal on-hook supervision state.
- The receive transmission path is powered down; the transmit path is powered up.
- The battery feed is connected to the high battery supply (Vватн).
- The current limiter is powered down and disabled.
- SW1 is closed; SW2 and SW3 are open.
- NSTAT reflects the status of the switchhook detector.


## Operating States (continued)

## Disconnect State

- Forward disconnect state.
- The receive transmission path is powered down; the transmit path is powered up.
- The current limiter is powered down and disabled.
- SW1, SW2, and SW3 are open.
- Pins PT, PR, and Vbf are high impedance (>100 k $\Omega$ ).
- NSTAT is forced high (on hook).


## Talk/High Battery State

- Alternate talk state.
- The battery feed is connected to the high battery supply (Vватн).
- The receive and transmit transmission paths are both powered up.
- The current limiter is powered up and active.
- SW1 and SW2 are closed; SW3 is open.
- NSTAT reflects the status of the switchhook detector.


## Talk State

- Normal talk state.
- The battery feed is connected to the low battery supply (Vвatl).
- The receive and transmit transmission paths are both powered up.
- The current limiter is powered up and active.
- SW2 is closed; SW1 and SW3 are open.
- NSTAT reflects the status of the switchhook detector.


## Scan Current-Limit State

- Alternate on-hook supervision state.
- Same as scan state but with the current limiter powered up and active.
- The receive transmission path is powered down; the transmit path is powered up.
- SW1 is closed; SW2 and SW3 are open.
- NSTAT reflects the status of the switchhook detector.


## Ringing State

- Normal ringing state.
- The receive and transmit transmission paths are both powered down.
- SW3 is closed; SW1 and SW2 are open.
- The current limiter is powered down and disabled.
- NSTAT reflects the status of the ring trip detector.


## On-Hook Transmission State

- Normal on-hook transmission state.
- The battery feed connected to the high battery supply (Vвatн).
- The receive and transmit transmission paths are both powered up.
- The current limiter is powered down and disabled.
- A 10 mA dc bias current flows out of the Ring current driver into PR and a 5 mA dc bias current flows into the Tip current driver from PT (the switchhook detector is adjusted to compensate for this dc bias current).
- SW1 and SW2 are closed; SW3 is open.
- NSTAT reflects the status of the switchhook detector.


## Intermediate Talk State

- Talk state with an increased and current-limited output impedance.
- Same as talk state.
- The current limiter is powered up and active.
- A 10 mA dc bias current flows out of the Ring current driver into PR and a 5 mA dc bias current flows into the Tip current driver from PT (the switchhook detector and current limiter are adjusted to compensate for this dc bias current).
- SW2 is closed; SW1 and SW3 are open.
- NSTAT reflects the status of the switchhook detector.


## Applications

## General

The L7597 supplies a precise differential current to the Tip/Ring pair (via PT and PR) as a function of analog signals on IRCV and RCVN. However, the current drivers connected to PT and PR are not designed to supply dc feed current to the loop. The dc loop current is fed by two external $200 \Omega$ resistors. When a loop is idle (on hook), the battery switch (SW1) is turned on to connect the Ring lead to Vватн which is typically -48 V ; thus providing sufficient Tip/Ring open circuit voltage to operate various types of customer premises equipment (CPE). Transmission may or may not be enabled in the idle dc feed condition. If transmission is enabled (onhook transmission), the current drivers are biased to a preset dc current ( 10 mA into PR and 5 mA out of PT) so that they can both source and sink sufficient signal current when no dc loop current is flowing (even in the presence of longitudinal currents on Tip and Ring). When the loop is off hook, the battery switch (SW1) is turned off and the current limiter becomes active. This connects the Ring lead to Vbatı (typically -25.5 V) through an accurate current-limiter circuit which saves off-hook power dissipation. Transmission is enabled in this dc feed condition, but the dc bias current in the drivers is turned off (hence, no increased power dissipation) because dc loop current is flowing.
The external $200 \Omega$ dc feed resistors will, for the most part, determine the longitudinal balance of the SLIC; thus, they must be matched appropriately to meet the longitudinal balance requirements ( $0.35 \%$ for 50 dB balance). The impedance of the battery switch and current limiter in series with the Ring-side dc feed resistor is reduced by the battery noise cancellation circuit so that it has minimal effect on the longitudinal balance.

The dc feed resistors also have a significant impact on the termination impedance of the SLIC. Some feedback, using external components, allows the user to adjust the termination impedance somewhat from the $400 \Omega$ dc feed resistance so that the primary application of the L7597 is for a $600 \Omega$ Ring resistive termination. Because the L7597 does not supply dc feed current to the loop, outputs PT and PR can be coupled to the Tip and Ring through a sufficiently high resistance to allow for simple lightning protection of the drivers. However, the resistance must be low enough to achieve the coupling of sufficient ac signal to the Tip and Ring from the available power supply. Since the Tip and Ring drivers are current sources, the value of this resistance does not affect the performance of the SLIC and is somewhat arbitrary. The value chosen is typically $1000 \Omega$.
The L7597 also senses the differential Tip/Ring voltage via sense inputs TS and RS. The differential dc voltage is used internally for switchhook detection. The detector threshold is preset internally. The differential Tip/ Ring ac signal appears on analog output XMT. Also included on the L7597 are three SCR protectors, a relay driver, one logic output (indicates switchhook and ring trip status), a 4-bit parallel logic interface, a ringing access switch, a ring trip detector, and a circuit which eliminates the battery noise that is coupled to the Tip and Ring through the dc feed resistors.
The following diagram and table shows the basic external components required with the L7597 SLIC. Specific component values are given in cases where the value is fixed. In cases where the value may change (i.e., components that determine the ac interface), the value is not listed but equations to determine these values are given later in this document.

Applications (continued)
General (continued)


12-3334.b (C)

* Optional to improve Vbatl PSRR by 6 dB .

Figure 5. External Components Required

## Applications (continued)

General (continued)
Table 15. External Components Required

| Comp. | Function | Implementation | Value | Attribute ${ }^{1}$ |
| :---: | :---: | :---: | :---: | :---: |
| F1 | Fuse Protector | Resistor Module | - | - |
| F2 | Fuse Protector | Resistor Module | - | - |
| R1 | dc Feed Protection | Resistor Module | $200 \Omega$ | 1.0\%, $2 \mathrm{~W}^{2}$ |
| R2 | dc Feed Protection | Resistor Module | $200 \Omega$ | 1.0\%, $2 \mathrm{~W}^{2}$ |
| R3 | Transmit Gain | Resistor Module | $100 \mathrm{k} \Omega$ | 1.0\%, $25 \mathrm{~mW}^{3}$ |
| R4 | Transmit Gain | Resistor Module | $100 \mathrm{k} \Omega$ | $1.0 \%, 25 \mathrm{~mW}^{3}$ |
| R5 | Transmit Gain | Resistor Module | $200 \mathrm{k} \Omega$ | $1.0 \%, 25 \mathrm{~mW}^{3}$ |
| R6 | Transmit Gain | Resistor Module | $200 \mathrm{k} \Omega$ | $1.0 \%, 25 \mathrm{~mW}^{3}$ |
| R7 | Protection | Resistor Module | $1 \mathrm{k} \Omega$ | 2.0\%, 0.1 W |
| R8 | Protection | Resistor Module | $1 \mathrm{k} \Omega$ | 2.0\%, 0.1 W |
| R9 | Battery Noise Cancellation | Resistor Module | $20 \mathrm{k} \Omega$ | $10 \mathrm{~mW}{ }^{4}$ |
| R10 | Ringing | Resistor Module | $600 \Omega$ | $\begin{gathered} 1.0 \%, 1.6 \mathrm{~W} \\ (14 \mathrm{~W} \text { for } 250 \mathrm{~ms}) \end{gathered}$ |
| Cvcc | Vcc Filter | External | $0.1 \mu \mathrm{~F}$ | 20\%, 10 V |
| Cvdd | Vdd Filter | External | $0.1 \mu \mathrm{~F}$ | 20\%, 10 V |
| Cbatl | Vbatl Filter | External | $0.1 \mu \mathrm{~F}$ | 20\%, 100 V |
| Cbath | Vвath Filter | External | $0.1 \mu \mathrm{~F}$ | 20\%, 100 V |
| Cıim | Current Limit | External | $0.1 \mu \mathrm{~F}$ | 20\%, 100 V |
| Rcbn1 | Battery Noise Cancellation | External | $5.11 \mathrm{k} \Omega$ | 1\%, 1/16 W |
| Rcbn2 | Battery Noise Cancellation | External | $301 \mathrm{k} \Omega$ | 1\%, 1/16 W |
| Ccbn3 | Battery Noise Cancellation | External | $0.1 \mu \mathrm{~F}$ | 20\%, 100 V |
| Ccbn4 | Battery Noise Cancellation | External | $0.01 \mu \mathrm{~F}$ | 20\%, 100 V |
| Cabn ${ }^{5}$ | Battery Noise Cancellation | External | 47 pF | 20\%, 100 V |
| Rgbs ${ }^{5}$ | Battery Noise Cancellation | External | $50 \mathrm{k} \Omega$ | 20\%, 100 V |
| Crt | Ring Trip | External | $0.1 \mu \mathrm{~F}$ | 1\%, 1/16 W |
| Rrt | Ring Trip | External | $1 \mathrm{M} \Omega$ | 20\%, 100 V |
| Cb1 | dc Blocking | External | $0.1 \mu \mathrm{~F}$ | 20\%, 10 V |
| Cв2 | dc Blocking | External | $0.1 \mu \mathrm{~F}$ | 20\%, 10 V |
| RT1 | ac Interface | External | See ac Design Equations | 1\%, 1/32 W |
| RT2 | ac Interface | External | See ac Design Equations | 1\%, 1/32 W |
| Rax | ac Interface | External | See ac Design Equations | 1\%, 1/32 W |
| Rax1 | ac Interface | External | See ac Design Equations | 1\%, 1/32 W |
| Rrv1 | ac Interface | External | See ac Design Equations | 1\%, 1/32 W |
| RRV2 | ac Interface | External | See ac Design Equations | 1\%, 1/32 W |
| Cs | ac Interface | External | See ac Design Equations | 1\%, 1/32 W |
| RнB1 | ac Interface | External | See ac Design Equations | 1\%, 1/32 W |

1. Power is continuous rms power.
2. $R_{1} / R_{2}=1$, with a tolerance of $0.35 \%$ for 50 dB longitudinal balance, $0.2 \%$ for 58 dB longitudinal balance. Fuses on F1 and F2 provide fail-safe operation if excessive overvoltage conditions exist on Tip and Ring. They will not operate if the total power dissipation of the entire resistor network is $\leq 5.0 \mathrm{~W}$ at $85^{\circ} \mathrm{C}$.
3. $\left(R_{3}+R_{6}\right) /\left(R_{4}+R_{5}\right)=1$ with a tolerance of $0.35 \%$ for 50 dB longitudinal balance, $0.2 \%$ for 58 dB longitudinal balance.
4. $R_{9} / R_{1}=100$ with a tolerance of $0.5 \%$.
5. Optional components to improve PSRR by 6 dB .

## Applications (continued)

## Resistor Module

The L7597 requires certain external resistors at the Tip and Ring interface. Because of matching and protection requirements, one of the most economical options recommended to implement these resistors is in a thick-film resistor module. A schematic and a brief description of the function of each of these resistors is given in Figure 6. Note that Microelectronic Modules Corporation* MMC A31A8574AA and MMC A11A8574AA thick-film resistor modules are application-specific resistor modules designed for use with the L7597 SLIC. The values, tolerance, matching, and power rating of the MMC A31A8574AA and MMC A11A8574AA modules are given in Table 16.
Resistors $R_{1}$ and $R_{2}$ are the dc feed resistors. $R_{1}$ is connected from battery to Ring and $R_{2}$ is connected from Tip to Ground. The dc loop current is fed to the subscriber loop via these resistors. The resistors set the dc feed resistance, which is $R_{1}+R_{2}(400=200+200)$.
Resistors $R_{1}$ and $R_{2}$ also provide a common-mode impedance of (200|| 200) $100 \Omega$. These resistors will primarily determine the longitudinal balance of the line circuit; thus they must be matched appropriately to meet longitudinal balance requirements ( $0.35 \%$ for 50 dB and $0.2 \%$ for 58 dB ). Also, they have a significant impact on the termination impedance of the SLIC. Feedback using external components (external components when a first- or secondgeneration codec is used) allows the user to set the termination impedance at $600 \Omega$, or most ITU-T recommended termination impedances.

Under normal operating conditions, the current through resistors $\mathrm{R}_{1}$ and $\mathrm{R}_{2}$ is limited by the current-limit circuitry to 25 mA . Thus, the 2 W rating of resistors $\mathrm{R}_{1}$ and $\mathrm{R}_{2}$ in MMC A31A8574AA and MMC A11A8574AA is adequate for normal operation. The power rating of these resistors is discussed more in the Protection section of this data sheet.

[^3]
## Applications (continued)

Resistor Module (continued)


5-5279 (F)
Notes:

1. Pin numbers and resistor labels are per MMC A31A8574AA and MMC A11A8574AA descriptions.
2. Node labels are per L7597 package.
3. For 600 V power cross, resistor networks should "open" in less than 40 ms .

Figure 6. Resistor Network

Table 16. MMC A31A8574AA and MMC A11A8574AA Module

| Resistor | Value | Tolerance | Power $^{1}$ | Surge Rating |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{R}_{1}$ | $200 \Omega$ | $1.0 \%$ | 2.0 W | Lightning: Power cross |
| $\mathrm{R}_{2}$ | $200 \Omega$ | $1.0 \%$ | 2.0 W | Lightning: Power cross |
| $\mathrm{R}_{3}$ | $100 \mathrm{k} \Omega$ | $1.0 \%$ | 25 mW | None |
| $\mathrm{R}_{4}$ | $100 \mathrm{k} \Omega$ | $1.0 \%$ | 25 mW | None |
| $\mathrm{R}_{5}$ | $200 \mathrm{k} \Omega$ | $1.0 \%$ | 25 mW | Lightning: Power cross |
| $\mathrm{R}_{6}$ | $200 \mathrm{k} \Omega$ | $1.0 \%$ | 25 mW | Lightning: Power cross |
| $\mathrm{R}_{7}$ | $1 \mathrm{k} \Omega$ | $2.0 \%$ | 0.1 W | Lightning: Power cross |
| $\mathrm{R}_{8}$ | $1 \mathrm{k} \Omega$ | $2.0 \%$ | 0.1 W | Lightning: Power cross |
| $\mathrm{R}_{9}$ | $20 \mathrm{k} \Omega$ | - | 10 mW | None |
| $\mathrm{R}_{10}$ | $600 \Omega$ | $1.0 \%$ | 1.6 W | 14 W for 250 ms |
| $\mathrm{R}_{9} / \mathrm{R}_{1}$ | 100 | $0.5 \%$ | - | - |
| $\mathrm{R}_{1} / \mathrm{R}_{2}$ | 1 | $0.35 \%{ }^{2}$ | - | - |
| $\left(\mathrm{R}_{3}+\mathrm{R}_{6}\right) /\left(\mathrm{R}_{4}+\mathrm{R}_{5}\right)$ | 1 | $0.35 \%{ }^{2}$ | - | - |

1. Continuous (RMS) power.
2. For 50 dB longitudinal balance; $0.2 \%$ for 55 dB balance.

Note: Fuses F1 and F2 provide fail-safe operation if excessive overvoltage conditions exist on Tip and Ring. They will not operate if the total power dissipation of the entire resistor network is $\leq 5.0 \mathrm{~W} @ 85^{\circ} \mathrm{C}$.

## Applications (continued)

## Resistor Module (continued)

Resistors R3-R6 set the gain of the SLIC in the transmit ( 2 -wire to 4 -wire) direction. This is shown in Figure 7.


5-5277 (F)
Figure 7. L7597 SLIC Matching Requirements

The matching of resistors R3-R6 will determine the gain accuracy of the SLIC; therefore, these resistors must be matched accordingly. Their matching requirements are given in Table 16.

Because of the high resistance values, the normal operating power of resistors $\mathrm{R}_{3}-\mathrm{R}_{6}$ will be relatively low. Given design margin and thick-film technology capabilities, a power rating of 250 mW for these resistors is not unreasonable.

Resistors $\mathrm{R}_{7}$ and $\mathrm{R}_{8}$ are used to couple the PT and PR current drive amplifiers to Tip and Ring. Since PT and PR drive amplifiers are current sources, the value of the series resistance does not affect the loop length or other performance of the SLIC, and may be arbitrarily high for protection purposes. A value of $1 \mathrm{k} \Omega$ is adequate for protection purposes.

Under normal operating conditions, these resistors will see the battery voltage less the Tip/Ring voltage.
Assuming a Tip/Ring voltage of 6 V (representative of a short into a handset), the normal continuous operating power of $R_{7}$ and $R_{8}$ is given by:
( $48 \mathrm{~V}-6 \mathrm{~V}$ ) E2/2.0 k $\Omega=0.882 \mathrm{~W}$
per R7 and R8 resistor pair
$882 \mathrm{~mW} / 2=441 \mathrm{~mW}$
per resistor ( $\mathrm{R}_{7}$ and $\mathrm{R}_{8}$ )

Hence, the operating power rating of 500 mW for $\mathrm{R}_{7}$ and $\mathrm{R}_{8}$. This is the normal rating for $\mathrm{R}_{7}$ and $\mathrm{R}_{8}$ under normal operating conditions. The ability of these resistors to withstand fault conditions depends on the power rating. Resistor R9 is also included on the thick-film resistor module. This resistor is used to set the gain of the battery noise cancellation circuit. See the Battery Noise Cancellation section of this data sheet for design equations to set the value of R9.

Power ringing is applied to the line circuit through resistor $\mathrm{R}_{10}$. One side of $\mathrm{R}_{10}$ is connected to L7597 node RSW. RSW is the output of the integrated solid-state ringing access switch, SW3. The other side of R10 is connected to the $200 \Omega$ Ring feed resistor, R1. Resistor R10 also serves as a current-limiting resistor. Fault current through the solid-state ringing access switch, SW3, is limited by R10. SW3 is rated for 2 A maximum for a $10 \mu \mathrm{~s} \times 1000 \mu \mathrm{~s}$ (lightning) pulse. Continuous current through this switch should be less than 150 mA . $\mathrm{R}_{10}$ in MMC resistor modules A31A8574AA and MMC A11A8574AA is chosen to be $600 \Omega$.

## Protection

Because of the resistive feed architecture, a simple inexpensive protection scheme that does not require an external protection device may be used. The MMC A31A8574 resistor module has specifications which are qualified to ITU-T K20, $U L^{*} 1459$, UL 497A, FCC Part 68.302 (d) \& (e), and REA Form 397G specification. The MMC A11A8574AA resistor module, in addition to meeting all the specifications of the MMC A31A8574, also meets Bellcore 1089 requirements.

Lightning and power-cross protection are provided by the two external dc feed (and current-limiting) resistors, $\mathrm{R}_{1}$ and $\mathrm{R}_{2}$, in the external resistor module. Under fault conditions, these resistors serve as fault currentlimiting resistors. These resistors are designed to survive lightning surges. They are also designed to continuously dissipate 4 W each and to survive 1 Arms @ 60 Hz power crosses of $\leq 1$ second in duration. Sustained power dissipation above these levels will cause degradation and eventual failure; however, the resistors are designed to fail gracefully under these conditions. Pins PT and PR are isolated from the loop by external $1000 \Omega$ resistors, and pin VbF is isolated from the loop by the Ring-side, $200 \Omega$ dc feed resistor. These pins must have adequate fault protection which operates outside of their normal operating voltages. All three pins are protected by SCRs which clamp the surge currents (both positive and negative) to FGND. The sense inputs, TS and RS, are protected with diodes to battery

[^4]
## Applications (continued)

## Protection (continued)

(Vвath) and Vcca and the series high-value external resistors which connect them to Tip and Ring. Because the battery noise cancellation input CBN is connected to pin VBF through a $0.1 \mu \mathrm{~F}$ capacitor, it must also be protected. Internally, it is protected with an 8 V zener diode connected to Vcca. An external resistor of at least $3 \mathrm{k} \Omega$ ( $5 \mathrm{k} \Omega$ is recommended) is required to limit the surge current. No external protector device is required.

## Tip/Ring Drivers

The L7597 has two Tip/Ring drivers whose outputs are PT and PR. Each driver operates as a current source capable of sinking or sourcing adequate ac signal current plus the dc bias current that is required during onhook transmission.

## Receive Interface

The receive interface circuitry couples the differential signal on receive inputs IRCV and RCVN to the Tip/ Ring drivers. Input IRCV is a low-impedance ( $<5 \Omega$ ) current input while RCVN is a high-impedance voltage input. Internal feedback forces the voltage at IRCV to be equal to RCVN so that a voltage applied to RCVN causes a current flow out of IRCV which equals that voltage divided by the impedance connected from IRCV to AGND (assuming the input voltage is referenced to AGND).
The receive interface and Tip/Ring drivers provide a current gain of 200; i.e., a differential output current flows from PT to PR which is 200 times the current flowing into IRCV. The receive interface also provides a level shift since the inputs, IRCV and RCVN, are referenced to analog ground, while the outputs, PT and PR, swing between Vcca and Vbath. The receive interface ensures that the input current is not converted to a common-mode current at PT and PR.

## Transmit Interface

The transmit interface circuitry interfaces the differential voltage on Tip and Ring to transmit output XMT. The Tip/Ring differential voltage (both ac and dc) appears on output XMT with a gain of 0.5 . The transmit interface uses an operational amplifier with four external resis-
tors to perform a differential to single-ended conversion. The operational amplifier inputs are TS and RS. Output XMT is referenced to ground (AGND). The longitudinal balance and gain accuracy at XMT depend on the matching of the external resistors ( $0.35 \%$ ).
Because a large dc potential exists at XMT, a capacitor must be used to couple the ac signal to the low-voltage codec circuitry.

## Battery Noise Cancellation

The battery noise cancellation circuit senses the ac noise on the battery via the capacitor connected from input CBN to Vbe. It couples this noise, $180^{\circ}$ out of phase, to the Ring current drive amplifier. This cancels the battery noise that is coupled to the Ring through the feed resistor connected to Vbr.

Additionally, it ensures longitudinal balance which depends only on the matching of the battery feed resistors by creating an ac ground at Vbf with respect to signals on the Ring lead.

For the cancellation to operate properly, both the phase and gain must be accurate. The battery noise cancellation gain is a transconductance which is equal to 100 divided by the resistor connected from RGBN to ground (AGND). This value must be equal to the reciprocal of the dc feed resistor $(1 / 200)$. That is:
$100 /$ R9 $=1 / 200$
$\mathrm{R} 9=20 \mathrm{k} \Omega$
It is advantageous if resistors R9 and $\mathrm{R}_{1}$ are matched and tracked thermally, i.e., located on the same film integrated circuit (FIC).
PSRR can be improved by adding a 47 pF capacitor in series with a $50 \mathrm{k} \Omega$ resistor from Rgbn to ground.
Also, to implement the battery noise cancellation function, connect the following circuit from CBN to VBF and analog ground.


5-5278 (F)
Figure 8. Implementing the Noise Cancellation Function

## Applications (continued)

## On-Hook Transmission

During the on-hook transmission and talk/on-hook transmission states, the L7597 provides 10 mA dc bias current out of the Ring current driver into PR and a 5 mA dc bias current into the Tip current driver from PT. The switchhook detector is adjusted to compensate for this dc bias current. The L7597 is able to support onhook transmission because of this bias. It is sufficiently high to drive a 3.17 dBm signal into a $600 \Omega$ or $900 \Omega$ ac loop. In order to conserve power, this bias is removed during the scan, active, and disconnect states.

## Parallel Data Interface

A 6-wire parallel interface (CE, CS, B0, B1, B2, and B3) is used to pass control information from the control logic on the line card to the L7597. The L7597 has eight operating states. These states are selected using three logic input bits, B0-B2, according to the truth table shown in Table 14. Logic input B3 operates a relay driver independent of the state of bits $\mathrm{B} 0-\mathrm{B} 2$. Data on the parallel data bus, B0-B3, is loaded into a 4-bit latch on the L7597 on the low-to-high transition of the channel select lead CS. Changes in the data at inputs B0—B3 do not affect the L7597 while CS is either low or high. A low on channel enable lead CE asynchronously resets the 4-bit latch to 1111 (scan state with the relay driver off) and disables the channel select lead CS (i.e., CS is prevented from loading any data into the 4-bit latch). A high on CE enables CS. State transitions and delays between transitions are left to the discretion of the user since, except for fault conditions, the state of the L7597 depends only on the external control provided through the logic interface.

## Supervision

The L7597 offers the ring trip, loop closure, and thermal shutdown functions. The status of these functions are provided as device outputs. The outputs of the ring trip and off-hook supervision functions are multiplexed into a single output, NSTAT. Whether the loop closure or ring trip detector output supervision function's output is seen at NSTAT is a function of the device state. The Device State Table (Table 14) details which supervision output (loop closure or Ring trip) is seen at NSTAT during a given device state.

Detector values are independent of office battery and are valid over the entire range of Vвath and Vbatl. How-
ever, NSTAT must indicate an on-hook (NSTAT = 1) if either Vbath or Vbatl is disconnected (open circuit) from its dc source and an off-hook (NSTAT = 0) if the L7597 is in thermal shutdown. $V_{\text {bath }}$ and $V_{\text {batl }}$ are defined as disconnected depending on the voltage at the power supply pins as follows (the pins of supplies which have more than one pin are shorted together):

If $\mathrm{V}_{\text {bath }} \leq-20 \mathrm{~V}$ (i.e., more negative than -20 V ) and Vbatl $\leq-20 \mathrm{~V}$, then NSTAT must operate normally. If $\mathrm{V}_{\text {bath }} \geq-10 \mathrm{~V}$ (i.e., more positive than -10 V ) or Vbatl $\geq-10 \mathrm{~V}$, then NSTAT must be on-hook (NSTAT = 1).
The status of the thermal shutdown circuit is output on B3 when CS is high (thermal shutdown $=0 \mathrm{~V}$ ).

## Off-Hook Detection

The off-hook or loop closure threshold on the L7597 SLIC is internally fixed and has a hysteresis. Off hook is indicated $($ NSTAT $=0)$ if the loop resistance is a maximum $3000 \Omega$. On hook is indicated (NSTAT $=1$ ) if the loop resistance is a minimum $5000 \Omega$.

## Ring Trip

The ring trip threshold is set by resistor R10 in the resistor module. With R10 set to $600 \Omega$, the circuit is guaranteed to ring trip up to $1330 \Omega$. With a 20 Hz ringing source, the trip time is guaranteed less than 200 ms . The ring trip circuit assumes use of battery-backed ringing. Pretrip immunity is such that a load across Tip and Ring of $10 \mathrm{k} \Omega$ in parallel with a $6 \mu \mathrm{~F}$ capacitor will not cause ring trip. Three external components are required for ring trip: a $1 \mathrm{M} \Omega$ resistor from RTS to $V_{B F}$; resistor $\mathrm{R}_{10}$, which is a $600 \Omega$ resistor from RSW to VBF; and a $0.1 \mu \mathrm{~F}$ capacitor from RSW to RTS. The components required for ring trip circuit are shown below. Note that $R_{10}$ is implemented in the resistor module. All other components are discrete.


5-5276 (F)
Figure 9. Ring Trip Threshold

## Applications (continued)

## Thermal Shutdown

If the silicon temperature rises above a nominal $145^{\circ} \mathrm{C}$, the L7597 will enter a thermal shutdown mode where all switches are off and the SLIC is in a state that is functionally equivalent to the disconnect state.

## Relay Driver

The L7597 offers a single integrated relay driver. The relay driver output RDO is low (relay operated) when a low input on B3 is latched into the device. The driver has sufficient driver capability to provide 70 mA with a 1.0 V drop and 20 mA with a 0.4 V drop. Turn-off and turn-on times are a maximum of $10 \mu \mathrm{~s}$.

## Solid-State Ringing Access

The L7597 offers solid-state ringing access switches for power ringing access and for the associated line break function. During the Ringing state, unbalanced battery-backed power ringing is applied to the Ring lead through resistors $R_{10}$ and $R_{1}$ via ringing access switch, SW3. The Ring drive amplifier of the L7597 SLIC is isolated from the subscriber loop via the integrated line break switch SW2 during the power ringing state. Since the Tip lead of the L7597 SLIC is tied to ground via resistor R2, no line break function is associated with the Tip lead. The return ground path for the power ringing signal is via R .
The line break switch, SW2, is implemented using a high-voltage MOS transistor. This gives a linear V-I characteristic, as seen in Figure 3. The ON resistance of this switch is a nominal $50 \Omega$ with a maximum $100 \Omega$. This switch is current limited to a nominal 35 mA and has a maximum off-state voltage rating of 320 V . The ringing access switch, SW3, is implemented using a pnpn type structure. This gives a linear V-I characteristic with an offset through the origin. The off-state voltage rating is 500 V . Surge current ( $10 \mu \mathrm{~s} \times 1000 \mu \mathrm{~s}$ ) through this switch must be limited to less than 2 A . Steady state current through this switch must be limited to less than 150 mA .

## Battery Switch

In order to minimize off-hook power consumption, the L7597 offers a battery switch feature. This feature is implemented using an integrated solid-state switch, SW1. The battery switch, SW1, has similar characteristics to the line break switch, SW2, including the 35 mA current limit. When SW1 is closed, the high-voltage battery is applied and any dc current from the high-voltage battery will be limited by the current-limiting action of SW1. When SW1 is open, the high-voltage battery is isolated from the loop. The low-voltage battery is applied through the current-limit circuit. When the cur-rent-limit circuit is active, the low-voltage battery is applied to the subscriber loop and dc current will be limited to 25 mA . When the current-limit circuit is not active, the low-voltage battery is isolated from the loop.
The state of SW1 is controlled via logic inputs B0—B2. Switch 1 determines if the high-voltage battery is applied to the loop. When SW1 is closed, the high-voltage battery is applied to the loop and the dc current from the high-voltage battery will be limited by the cur-rent-limit action of SW1. When SW1 is open, the highvoltage battery is isolated from the loop.
The low-voltage battery is applied to the loop when the current-limit circuitry is active, regardless of the state of SW1. If the current-limit circuit is not active, then the low-voltage battery is isolated from the loop. Whenever the current-limit circuitry is active, current from the lowvoltage battery is limited to 25 mA . The talk state is an example of this mode of operation.
It is possible to have both the high-voltage and low-voltage battery applied to the loop. In the high-battery talk state, the current limiter is active and SW1 is closed. Thus, dc loop current is drawn from both batteries. The current from the high battery is limited to the current limit of SW1, 35 mA nominal, and the current from the low-voltage battery is limited to 25 mA by the currentlimit circuit. Thus, in this state, overall dc current is limited to a nominal 60 mA .
In TA-909, or other short loop application, typically the high-voltage battery is applied during scan and other on-hook states. This is to maintain compatibility with any existing standards for customer premises equipment. In TA-909, the minimum loop is $450 \Omega$. Given this short loop range, the lower-voltage battery has sufficient capability to ensure that 18 mA is fed to any loop in this range. Thus, whenever the handset set goes off hook, in order to conserve power, operation is switched to the lower-voltage battery.

## dc Characteristics

## V-I Characteristics

Resistors $R_{1}$ and $R_{2}$ are the dc feed resistors. $R_{1}$ is connected from battery to Ring, and R2 is connected from Tip to Ground. The dc loop current is fed to the subscriber loop via these resistors. In short loop applications, to minimize power consumption, the lowervoltage battery is used to supply dc current to the subscriber loop and this current is limited by the internal current-limit circuitry. In the talk state, the lowervoltage battery is applied to the loop and the dc cur-rent-limit circuitry is active. When the lower-voltage battery is used, the loop length must be short enough such that the battery voltage less overheads is capable of supplying sufficient dc loop current to allow for proper operation of the handset. Typically a minimum 18 mA is required. In this mode of operation, the V-I template is restricted to short loop lengths and the current is limited to 25 mA for all allowed loop lengths.

## Loop Length

The loop range when operating from the lower voltage battery in current limit is given by:

Where $R L$ is the dc resistance of the subscriber loop, specified in TA-909 as $450 \Omega$ minimum. Vонцім is the overhead or drop associated with the current-limit circuit; typically 2.2 V lІмIT is the current-limit value $(25 \mathrm{~mA}) .\left|V_{\text {bat }}\right|$ is the magnitude of the lower voltage battery; recommended 25.5 V .
$\mathrm{R}_{1}=\mathrm{R}_{2}=$ dc feed resistors $=200 \Omega$
$R \mathrm{~L}=(\{25.5 \mathrm{~V}-2.2 \mathrm{~V}\} / 0,025 \mathrm{~A})-200 \Omega-200 \Omega=$ $532 \Omega$
$\mathrm{RL}=532 \Omega \geq 450 \Omega$

## ac Design

## Codec Features and Selection Summary

There are four key ac design parameters:

- Termination impedance is the impedance looking into the 2 -wire port of the line card. It is set to match the impedance of the telephone loop in order to minimize echo return to the telephone set.
- Transmit gain is measured from the 2 -wire port to the PCM highway.
- Receive gain is done from the PCM highway to the transmit port.
- Hybrid balance network cancels the unwanted amount of the receive signal that appears at the transmit port.

At this point in the design, the codec needs to be selected. The discrete network between the SLIC and the codec can then be designed. Below is a brief codec feature and selection summary.

## First-Generation Codecs

These perform the basic filtering, A/D (transmit), D/A (receive), and $\mu$-law/A-law companding. They all have an op amp in front of the A/D converter for transmit gain setting and hybrid balance (cancellation at the summing node). Depending on the type, some have differential analog input stages, differential analog output stages, and $\mu$-law/A-law selectability. This generation of codec has the lowest cost. It is most suitable for applications with fixed gains, termination impedance, and hybrid balance.

## Second-Generation Codecs

This class of devices includes a microprocessor interface for software control of the gains and hybrid balance. The hybrid balance is included in the device. ac programmability adds application flexibility and saves several passive components. It also adds several I/O latches that are needed in the application. It does not have the transmit op amp, since the transmit gain and hybrid balance are set internally.

## Third-Generation Codecs

This class of devices includes the gains, termination impedance, and hybrid balance-all under microprocessor control. Depending on the device, it may or may not include latches.

In the codec selection, increasing software control and flexibility are traded for device cost. To help decide, it may be useful to consider the following:

- Will the application require only one value for each gain and impedance?
- Will the board be used in different countries with different requirements?
- Will several versions of the board be built? If so, will one version of the board be most of the production volume?
- Does the application need only real termination impedance?
- Does the hybrid balance need to be adjusted in the field?


## ac Design (continued)

## Design Equations

The following section gives the relevant design equations to choose component values for any desired gain, termination, and balance network, assuming a complex termination is desired. Complex termination will be specified in one of the two forms shown below:


Figure 10. Equivalent Complex Terminations

Both forms are equivalent to each other, and it does not matter which form is specified. The component values in the interface circuit of Figure 10 are calculated assuming the parallel form is specified. If the termination impedance to be synthesized is specified in the series form, convert it to the parallel form using the equations below:

$$
\begin{gathered}
R_{1}^{\prime}=R_{1}+R_{2} \\
R_{2}^{\prime}=\frac{R_{1}{ }^{2}+R_{2} R_{1}}{R_{2}} \\
C^{\prime}=\frac{C}{1+2 \frac{R 1}{R_{2}}+\left(\frac{R 1}{R_{2}}\right)^{2}}
\end{gathered}
$$

Note that if the termination impedance is specified as pure resistive:

$$
\mathrm{R}_{2}=\mathrm{R}^{\prime}=0 \text { and } \mathrm{C}=\mathrm{C}^{\prime}=\infty
$$

Define the gain constant, K , as follows:

$$
\begin{aligned}
& \mathrm{KRCV}=\mathrm{K}_{0} 10^{\mathrm{RX} / 20} \text { for receive gain } \\
& \mathrm{KTX}=\frac{1}{\mathrm{~K}_{0}} 10^{T \mathrm{X} / 20} \text { for transmit gain }
\end{aligned}
$$

Where,

$$
\begin{aligned}
R x= & \text { desired receive (or PCM to Tip/Ring) gain } \\
& \text { in } d B
\end{aligned}
$$

$\mathrm{Tx}=$ desired transmit (or Tip/Ring to PCM) gain in dB

$$
\mathrm{K}_{0}=\sqrt{\frac{\mathrm{Z}_{\mathrm{T}} \mid 1 \mathrm{kHz}}{600}}=\text { power transfer ratio }
$$

$\left|Z_{T}\right| 1 \mathrm{kHz}$ is the magnitude of the complex termination impedance ZT being synthesized, calculated at 1000 Hz . This equation assumes that the TLP of the codec is 0 dBm referenced to $600 \Omega$.
The following equation applies when referring to Figure 10:

$$
Z T=\frac{\omega^{2} C^{2} R_{1} R_{2}^{2}+R_{1}+R_{2}-j \omega R_{2}^{2} C}{1+\omega^{2} R_{2}^{2} C^{2}}
$$

Where,

$$
\begin{aligned}
& \omega=2 \pi f \\
& f=1000 \mathrm{~Hz}
\end{aligned}
$$

$\mathrm{CR}_{1} \mathrm{R}_{2}$ is defined per Figure 10 (series form), and

$$
\left|Z_{T}\right|=\sqrt{\left(\frac{\omega^{2} C^{2} R_{1} R_{2}{ }^{2}+R_{1}+R_{2}}{1+\omega^{2} R_{2}{ }^{2} C^{2}}\right)^{2}+\left(\frac{\omega R_{2}{ }^{2} C}{1+\omega^{2} R_{2}{ }^{2} C^{2}}\right)^{2}}
$$

ac Design (continued)
Design Equations (continued)


Figure 11. Initial ac Interface for Complex Termination Between L7597 SLIC and T7504 Codec Note: dc Blocking Capacitor (Св) Not Shown, Ст and $\mathrm{C}_{\text {r }}$ Separate

The Tip/Ring differential current is given by:

$$
I_{T / R}=200\left(I_{R P}-\frac{V_{\mathrm{RN}}}{\mathrm{ZIRP}^{2}}\right)
$$

The voltage at pin XMT is given by:

$$
V_{\text {xмt }}=\frac{-V_{T / R}}{2}
$$

The component values in the ac interface of Figure 11 are calculated (for the transmit and receive gains defined by the respective gain constants $K_{r x}$ and $K_{r c v}$, and for the termination impedance seen in Figure 10) using the following equations:

$$
\begin{aligned}
& R_{R V 1}=\frac{100 R_{1} \prime^{\prime}}{K_{R C V}} \\
& R_{R V 2}=\frac{100 R_{2}^{\prime}}{K_{R C V}} \\
& C_{R}=\frac{K_{R C V C^{\prime}}}{100}
\end{aligned}
$$

$$
\begin{aligned}
& \frac{R_{G X 1}}{\operatorname{RGX1}_{1}+\mathrm{R}_{\mathrm{T} 1}}=\frac{\mathrm{RRVV}_{1}}{100}\left(\frac{1}{400}-\frac{1}{\mathrm{R}_{1}{ }^{\prime}}\right) \\
& 400 \Omega=2 \times 200 \Omega \text { feed resistors } \\
& R_{g x}=2{ }^{*} K_{t x}\left(R_{g x} 1+R_{t 1}\right) \\
& C_{T}=\frac{\mathrm{C}^{\prime}}{100}\left[1+\frac{\mathrm{RGX}_{1}}{\mathrm{R}_{\mathrm{T} 1}}\left(1+\frac{100 \mathrm{R}_{1}{ }^{\prime}}{\mathrm{RRV}_{1}}\right)\right] \\
& \mathrm{R}_{\mathrm{T} 2}=\frac{\mathrm{R}_{2}{ }^{\prime} \mathrm{C}^{\prime}}{\mathrm{C}_{\mathrm{T}}}
\end{aligned}
$$

The $200 \Omega$ feed resistors contribute $400 \Omega$ to the termination impedance. The termination impedance associated with the circuit in Figure 11 consists of this inherent $400 \Omega$ feeding impedance in parallel with:

- A negative impedance, where,

$$
\frac{2}{100} \times \frac{R_{G \times 1}}{R_{\mathrm{G} \times 1}+R_{T 1}}
$$

- And a positive impedance, where,

$$
\left(R_{T} 2+\frac{1}{j \omega C_{T}}\right) \cdot\left(\frac{R_{G X 1}+R_{T 1}}{R_{T 1}}\right)
$$

The negative and positive impedance terms are used to adjust the termination impedance from the inherent $400 \Omega$ to any complex termination.

## ac Design (continued)

Design Equations (continued)


12-3426(F).r3
Figure 12. Revised ac Interface $\mathrm{Ct}_{\mathrm{t}}$ and $\mathrm{C}_{\text {R }}$ Combined into a Single Capacitor $\mathrm{Cs}^{2}$

Using the circuit of Figure 11, the ratio of capacitors $\mathrm{C}_{\mathrm{T}}$ and $\mathrm{C}_{R}$ will affect the gain flatness (transmit and receive), and to a lesser degree the return loss of the line circuit. Thus, depending on the requirements, $\mathrm{CT}_{T}$ and Cr may need to be tight tolerance capacitors.
If this is the case, capacitors $\mathrm{C}_{\mathrm{t}}$ and $\mathrm{C}_{R}$ may be combined into a single capacitor with a looser tolerance. This is illustrated in Figure 12.

To scale Cs (higher), increase Cт (and decrease RT2) by increasing the Rax1/ ( $\mathrm{Rax}_{\mathrm{ax}}+\mathrm{R}_{\mathrm{T} 1}$ ) ratio by rearranging the circuit in Figure 11 and by adding resistor Rsc from XMT to IRP as shown below:


12-3427(F)
Figure 13. Addition of Resistor Rsc from XMT to IRP

Then,

$$
\frac{R_{G X 1}}{R_{G X 1}+R_{T 1}}=\frac{\left(R_{R V} 1 \| R_{s C}\right)}{100}\left(\frac{1}{600}-\frac{1}{R_{1} 1^{\prime}}\right)+\frac{R_{R V} 1}{R_{R V} 1+R_{s C}}
$$

Once the gains and complex termination are set, if the hybrid balance network is identical to the termination impedance, then the hybrid balance is set by a single resistor (shown in Figure 11) and is computed as follows:

$$
R_{H B}=\frac{R_{G X}}{K_{T X} \times K_{R C V}}
$$

The L7597 SLIC is ground referenced. However, a +5 V only codec, such as T 7504 , is referenced to +2.5 V . The L7597 SLIC has sufficient dynamic range to accommodate an ac signal from the codec that is referenced to +2.5 V without clipping distortion. Furthermore, a dc current will flow between the L7597 SLIC and +5 V only codec. With the L7597 SLIC, this current will not affect ac performance, but it does waste power. To avoid wasted power consumption, blocking capacitors can be added. Capacitors should be placed to block any path from any low-impedance +2.5 V biased node on the T7504 codec (or other +5 V only codec) to the SLIC. A blocking capacitor (Св) has been added in the application drawing in Figure 13.
After the blocking capacitor $\mathrm{CB}_{\mathrm{B}}$ is added, the above component values may have to be adjusted slightly to optimize performance.
The effects of the blocking capacitor are best evaluated and optimized by circuit simulation. Contact your Lucent Technologies Microelectronics Group Account Representative for information on availability of a PSPICE* model.
ac Design (continued)
Design Equations (continued)
As a practical design example, design the interface for the following set of requirements per TA-909.
$R X=-4 d B$
$T X=-2 d B$
$\mathrm{ZT}=600 \Omega \longrightarrow\left(\mathrm{R}_{1}=600 ; \mathrm{R}_{2}=0 ; \mathrm{C}=\infty\right)$
$\mathrm{Hy}=600 \Omega$
Thus:
$R 1^{\prime}=600 \Omega$
$R_{2}{ }^{\prime}=0$
$\mathrm{C}^{\prime}=\infty$
Calculate the gain constants:
$\mathrm{Ko}=\sqrt{\frac{Z_{T} \mid 1 \mathrm{kHz}}{600}}=\sqrt{\frac{600}{600}}=1$.
$\mathrm{K} R C V=\mathrm{K}_{1} 10^{\mathrm{RX} / 20}=1 \times 10^{-4 / 20}=0.631$
$\mathrm{K}_{\mathrm{TX}}=\frac{1}{\mathrm{Ko}_{0}} 10^{\mathrm{TX} / 20}=1 \times 10^{-2 / 20}=0.794$
Calculate individual components:
$R_{R V 1}=\frac{100 R_{1}{ }^{\prime}}{K_{R C V}}=\frac{100 \times 600}{0.631}=95.1 \mathrm{k} \Omega$
Using a standard value component:
RRV1 $=95.3 \mathrm{k} \Omega$
$\operatorname{RRV}_{2}=\frac{100 \mathrm{R}^{\prime}{ }^{\prime}}{\mathrm{RRCV}^{\prime}}=0$
$C_{R}=\frac{\mathrm{K}_{\text {RCVC }}{ }^{\prime}}{100}=\infty$

$$
\frac{R_{G X 1}}{R_{G \times 1}+R_{T 1}}=\frac{R_{R V 1}}{100}\left(\frac{1}{400}-\frac{1}{R_{1}^{\prime}}\right)
$$

Choose Rax1 $=82.5 \mathrm{k} \Omega$

$$
\frac{82.5 \mathrm{k} \Omega}{82.5 \mathrm{k}+\mathrm{R}_{\mathrm{T} 1}}=\frac{95.3 \mathrm{k} \Omega}{100}\left(\frac{1}{400}-\frac{1}{600}\right)
$$

$$
\mathrm{R}_{\mathrm{T} 1}=21.4 \mathrm{k} \Omega
$$

Using a standard value component:
$\mathrm{R}_{\mathrm{T} 1}=21.5 \mathrm{k}$
$C_{T}=\frac{C^{\prime}}{100}\left[1+\frac{R_{G X 1}}{R_{T 1}}\left(1+\frac{100 R_{1}{ }^{\prime}}{R_{R V 1}}\right)\right]$
$\mathrm{CT}=\infty$
$\mathrm{R}_{\mathrm{T}} 2=\frac{\mathrm{R}^{\prime} \mathrm{C}^{\prime}}{\mathrm{C}^{\prime}}=0$

$R_{\mathrm{Gx}}=2 \times 0.794(82.5+21.5)=165.2 \mathrm{k} \Omega$
Using a standard value component:
Rgx $=165 \mathrm{k} \Omega$
$R_{H B}=\frac{R_{G X}}{K_{T X} \times K_{R C V}}$
RHB $=\frac{165 \mathrm{k} \Omega}{0.794 \times 0.631}=329 \mathrm{k} \Omega$
Using a standard value Rнв $=332 \mathrm{k} \Omega$.
Therefore, for this design example, use the following values in the circuit shown in Figure 11.
$\mathrm{R}_{\mathrm{T} 1}=21.5 \mathrm{k} \Omega$
$\mathrm{R}_{\mathrm{T} 2}=0$
Rgx $=165 \mathrm{k} \Omega$
$\mathrm{Raxx}_{1}=82.5 \mathrm{k} \Omega$
RRV1 $=95.3 \mathrm{k} \Omega$
RRV2 $=0$
Rнв $1=332 \mathrm{k} \Omega$
СТ $=\infty$
$\mathrm{C}_{\mathrm{R}}=\infty$
Figure 14 is the application circuit with the above values.

## TA-909 Application Diagram

In the following diagram:
$R X=-4 d B$
$T X=-2 d B$
$\mathrm{ZT}=600 \Omega$
$\mathrm{Hy}=600 \Omega$


12-3334.a (C)

* Optional to improve Vbatl PSRR by 6 dB .

Figure 14. TA-909 Application Diagram

## Outline Diagram

## 32-Pin PLCC

Dimensions are in millimeters.


## Ordering Information

| Device Part No. | Description | Package | Comcode |
| :---: | :---: | :---: | :---: |
| ATTL7597BAU-D | Resistive SLIC, Ring Relay, and Protector <br> for Short Loop and TA-909 Applications | 32-Pin PLCC <br> (Dry-bagged) | 107874802 |
| ATTL7597BAU-DT | Resistive SLIC, Ring Relay, and Protector <br> for Short Loop and TA-909 Applications | 32-Pin PLCC <br> (Tape and Reel, Dry-bagged) | 107861155 |

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[^0]:    * MMC is a registered trademark of Microelectronic Modules Corporation

[^1]:    * On the printed-wiring board (PWB), make the leads to FGND and VBF as wide as possible for thermal and electrical reasons. Also, maximize the amount of PWB copper on all leads connected to this device for the lowest operating temperature.

[^2]:    1. A battery or ground short on PT, PR, or XMT shall not cause a device failure.
    2. This parameter is not tested in production. It is guaranteed by design and device characterization.
[^3]:    * For additional information, contact Microelectronic Modules Corporation (MMC), 2601 S. Moorland Rd., New Berlin, WI 53151 U.S.A.: Tel. 414-785-6506, FAX 414-785-6516, e-mail sales@mmccorp.com.

[^4]:    * UL is a registered trademark of Underwriters Laboratories, Inc.

